

3.2x1.6 mm SMD CHIP LED LAMP

PRELIMINARY SPEC



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APK3216VGC/A-F01

Features

- 3.2mmx1.6mm SMT LED, 1.1mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACK LIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

Description

The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

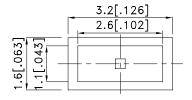
Green

Static electricity and surge damage the LEDS.

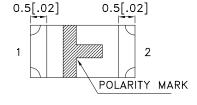
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

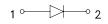
Package Dimensions

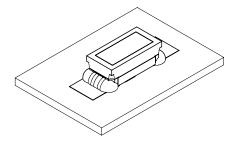












- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

| Part No. | Dice | Iv (mcd) [2] Dice Lens Type @ 20mA | | , | Viewing Angle [1] |
|------------------|---------------|--|------|------|----------------------|
| | | | Min. | Тур. | 201/2 |
| APK3216VGC/A-F01 | Green (InGaN) | WATER CLEAR | 70 | 200 | 90° |

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|--------|------|------|-------|--------------------|
| λpeak | Peak Wavelength | Green | 520 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Green | 525 | | nm | I==20mA |
| Δλ1/2 | Spectral Line Half-width | Green | 35 | | nm | IF=20mA |
| С | Capacitance | Green | 100 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Green | 3.2 | 4 | V | IF=20mA |
| lr | Reverse Current | Green | | 10 | uA | V _R =5V |

Notes:

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

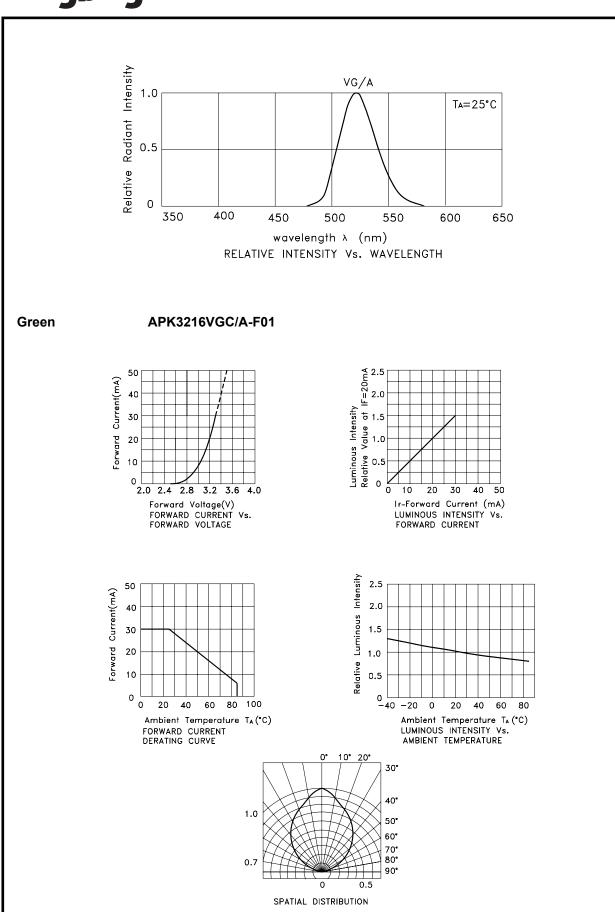
Absolute Maximum Ratings at TA=25°C

| Parameter | Green | Units | |
|--------------------------|----------------|-------|--|
| Power dissipation | 120 | mW | |
| DC Forward Current | 30 | mA | |
| Peak Forward Current [1] | 100 | mA | |
| Reverse Voltage | 5 | V | |
| Operating Temperature | -40°C To +85°C | | |
| Storage Temperature | -40°C To +85°C | | |

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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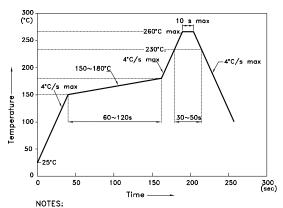


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APK3216VGC/A-F01

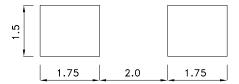
Reflow Soldering Profile For Lead-free SMT Process.



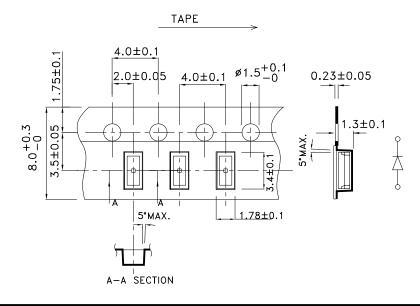
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



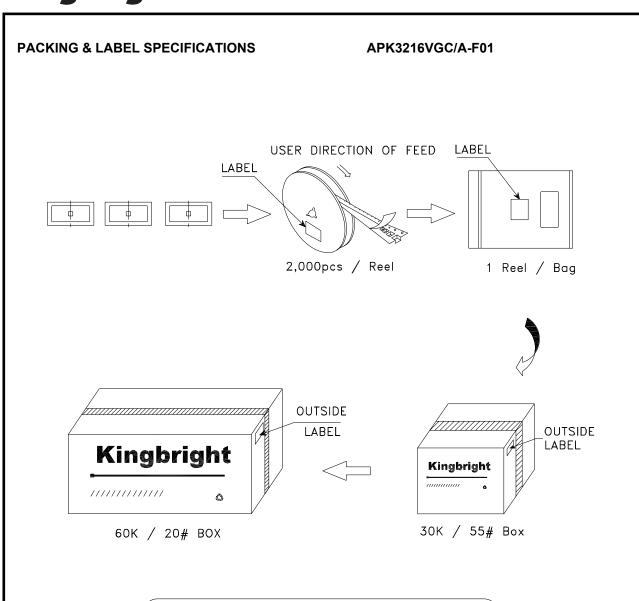
Tape Specifications (Units: mm)



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